

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE Group Art Unit 1742



In re

Patent Application of

Toshihide Ito

Application No. 09/671,084

Confirmation No.: 6569

Filed: September 27, 2000

Examiner: Sikyin Ip

"SN-AG-CU SOLDER AND SURFACE TREATMENT AND PARTS MOUNTING METHODS USING THE SAME"

I, Elizabeth M. Campbell Tressler, hereby certify that this correspondence is being deposited with the US Postal Service as first class mail in an envelope addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date of my signature

Signature

2/1/05

**NOTICE OF APPEAL** 

Mail Stop AF Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Applicant hereby appeals to the Board of Patent Appeals and Interferences from the decision dated November 2, 2004 of the Examiner finally rejecting Claims 1-3, 5, 6 and 8.

A check in the amount of \$500.00 is enclosed to cover the cost of filing this Notice of Appeal. Please charge any additional fees or credit any overpayment to Deposit Account No. 50-1965.

Date:

2/1/05

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File No. 200335-0037

Respectfully submitted,

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